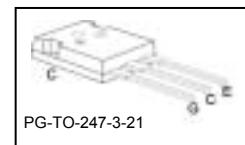
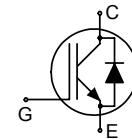




Reverse Conducting IGBT with monolithic body diode

Features:

- 1.5V typical saturation voltage of IGBT
- Trench and Fieldstop technology for 900 V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - easy parallel switching capability due to positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Qualified according to JEDEC¹ for target applications
- Application specific optimisation of inverse diode
- Pb-free lead plating; RoHS compliant



Applications:

- Microwave Oven
- Soft Switching Applications for ZCS

| Type | V_{CE} | I_C | $V_{CE(sat), T_j=25^\circ C}$ | $T_{j,max}$ | Marking | Package |
|-----------|----------|-------|-------------------------------|-------------|---------|----------------|
| IHW30N90R | 900V | 30A | 1.5V | 175°C | H30R90 | PG-T0-247-3-21 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|-----------|----------------------|------------|
| Collector-emitter voltage $T_C = 25^\circ C$ $T_C = 100^\circ C$ | V_{CE} | 900 | V |
| DC collector current $T_C = 25^\circ C$ $T_C = 100^\circ C$ | I_C | 60 | A |
| Pulsed collector current, t_p limited by $T_{j,max}$ | | 30 | |
| Turn off safe operating area $V_{CE} \leq 1200V$, $T_j \leq 150^\circ C$ | - | 90 | |
| Diode forward current $T_C = 25^\circ C$ $T_C = 100^\circ C$ | I_F | 60 | |
| Diode pulsed current, t_p limited by $T_{j,max}$ | | 30 | |
| Gate-emitter voltage Transient Gate-emitter voltage ($t_p < 5$ ms) | V_{GE} | ± 20 ± 25 | V |
| Power dissipation, $T_C = 25^\circ C$ | P_{tot} | 454 | W |
| Operating junction temperature | T_j | -40...+175 | $^\circ C$ |
| Storage temperature | T_{stg} | -55...+175 | $^\circ C$ |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s | - | 260 | |

¹ J-STD-020 and JESD-022

**Thermal Resistance**

| Parameter | Symbol | Conditions | Max. Value | Unit |
|--|-------------|------------|------------|------|
| Characteristic | | | | |
| IGBT thermal resistance, junction – case | R_{thJC} | | 0.33 | K/W |
| Diode thermal resistance, junction – case | R_{thJCD} | | 0.33 | |
| Thermal resistance, junction – ambient | R_{thJA} | | 40 | |

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | | | Unit |
|--------------------------------------|----------------------|---|-------|------|------|---------------|
| | | | min. | Typ. | max. | |
| Static Characteristic | | | | | | |
| Collector-emitter breakdown voltage | $V_{(BR)CES}$ | $V_{GE}=0\text{V}, I_C=0.5\text{mA}$ | 900 | - | - | V |
| Collector-emitter saturation voltage | $V_{CE(\text{sat})}$ | $V_{GE} = 15\text{V}, I_C=30\text{A}$ | - | 1.5 | 1.7 | |
| | | $T_j=25^\circ\text{C}$ | - | 1.6 | - | |
| | | $T_j=150^\circ\text{C}$ | - | 1.7 | - | |
| | | $T_j=175^\circ\text{C}$ | - | 1.7 | - | |
| Diode forward voltage | V_F | $V_{GE}=0\text{V}, I_F=30\text{A}$ | - | 1.4 | 1.6 | |
| | | $T_j=25^\circ\text{C}$ | - | 1.4 | - | |
| | | $T_j=150^\circ\text{C}$ | - | 1.45 | - | |
| | | $T_j=175^\circ\text{C}$ | - | 1.45 | - | |
| Gate-emitter threshold voltage | $V_{GE(\text{th})}$ | $I_C=700\mu\text{A}, V_{CE}=V_{GE}$ | 5.1 | 5.8 | 6.4 | |
| Zero gate voltage collector current | I_{CES} | $V_{CE}=900\text{V},$ $V_{GE}=0\text{V}$ | - | - | 5 | μA |
| | | $T_j=25^\circ\text{C}$ | - | - | 2500 | |
| | | $T_j=150^\circ\text{C}$ | - | - | 2500 | |
| Gate-emitter leakage current | I_{GES} | $V_{CE}=0\text{V}, V_{GE}=20\text{V}$ | - | - | 600 | nA |

**Dynamic Characteristic**

| | | | | | | |
|---|------------|---|---|------|---|----|
| Input capacitance | C_{iss} | $V_{CE}=25V$, $V_{GE}=0V$, $f=1MHz$ | - | 2889 | - | pF |
| Output capacitance | C_{oss} | | - | 83 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 79 | - | |
| Gate charge | Q_{Gate} | $V_{CC}=720V$, $I_C=30A$ $V_{GE}=15V$ | - | 200 | - | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | L_E | | - | 13 | - | nH |

Switching Characteristic, Inductive Load, at $T_j=25^\circ C$

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------|--------|------------|-------|------|------|------|
| | | | min. | Typ. | Max. | |

IGBT Characteristic

| | | | | | | |
|------------------------|--------------|---|---|------|---|----|
| Turn-off delay time | $t_{d(off)}$ | $T_j=25^\circ C$ $V_{CC}=600V$, $I_C=30A$, $V_{GE}=0/15V$, $R_G= 15\Omega$ | - | 511 | - | mJ |
| Fall time | t_f | | - | 24 | - | |
| Turn-on energy | E_{on} | | - | - | - | |
| Turn-off energy | E_{off} | | - | 1.46 | - | |
| Total switching energy | E_{ts} | | - | 1.46 | - | |

Switching Characteristic, Inductive Load, at $T_j=175^\circ C$

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------|--------|------------|-------|------|------|------|
| | | | min. | Typ. | max. | |

IGBT Characteristic

| | | | | | | |
|------------------------|--------------|--|---|-----|---|----|
| Turn-off delay time | $t_{d(off)}$ | $T_j=175^\circ C$ $V_{CC}=600V$, $I_C=30A$, $V_{GE}=0/15V$, $R_G= 15\Omega$ | - | 594 | - | mJ |
| Fall time | t_f | | - | 46 | - | |
| Turn-on energy | E_{on} | | - | - | - | |
| Turn-off energy | E_{off} | | - | 2.1 | - | |
| Total switching energy | E_{ts} | | - | 2.1 | - | |

Soft Switching Series

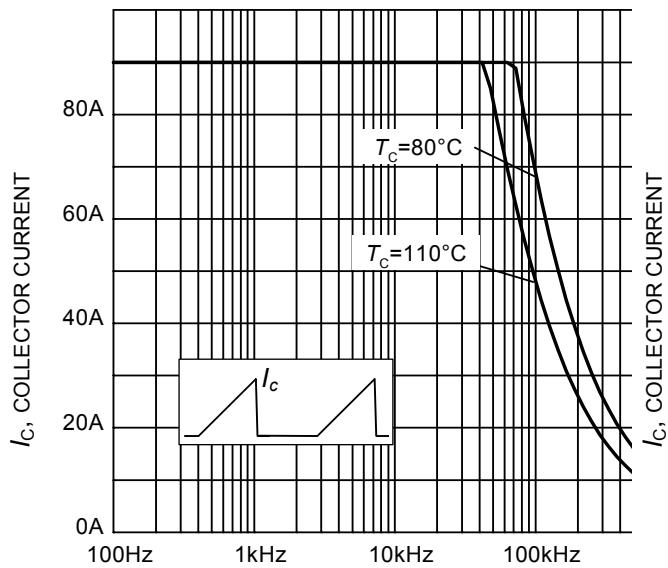
 f , SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency for triangular current ($E_{on} = 0$, hard turn-off)
 $(T_j \leq 175^\circ\text{C}, D = 0.5, V_{CE} = 600\text{V}, V_{GE} = 0/+15\text{V}, R_G = 15\Omega)$

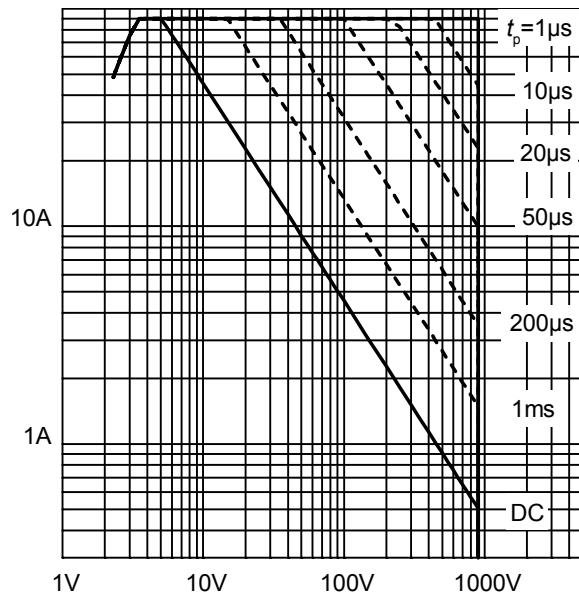
 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 2. IGBT Safe operating area
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 175^\circ\text{C}; V_{GE} = 15\text{V})$

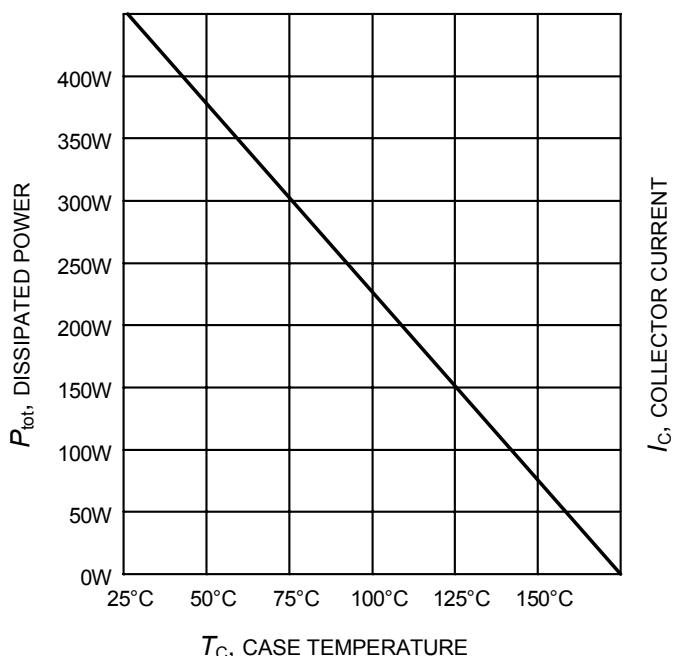
 T_C , CASE TEMPERATURE

Figure 3. Power dissipation as a function of case temperature
 $(T_j \leq 175^\circ\text{C})$

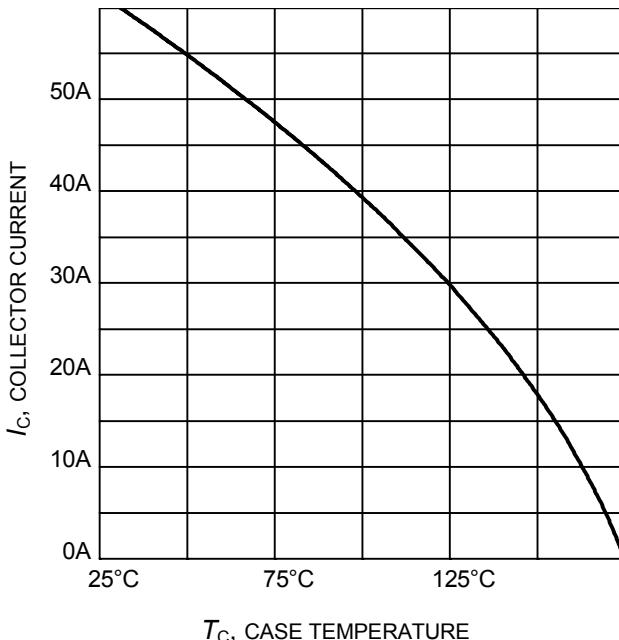
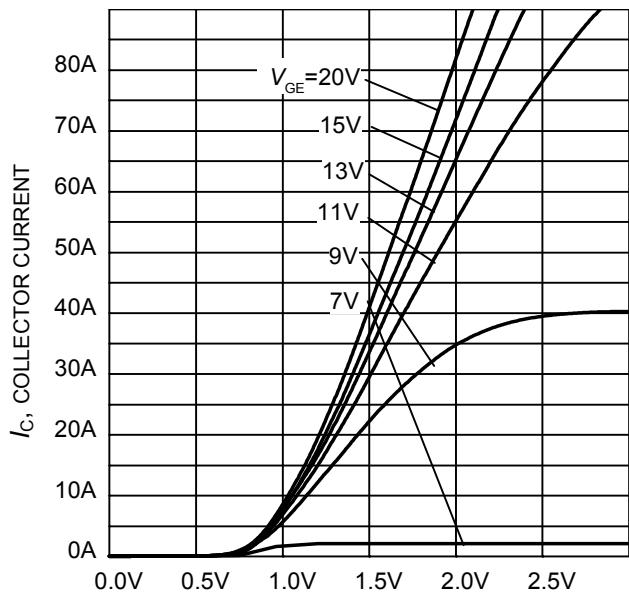
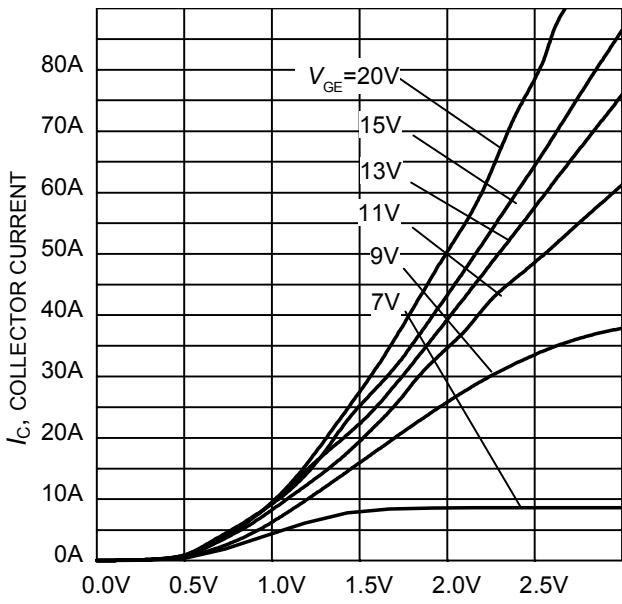
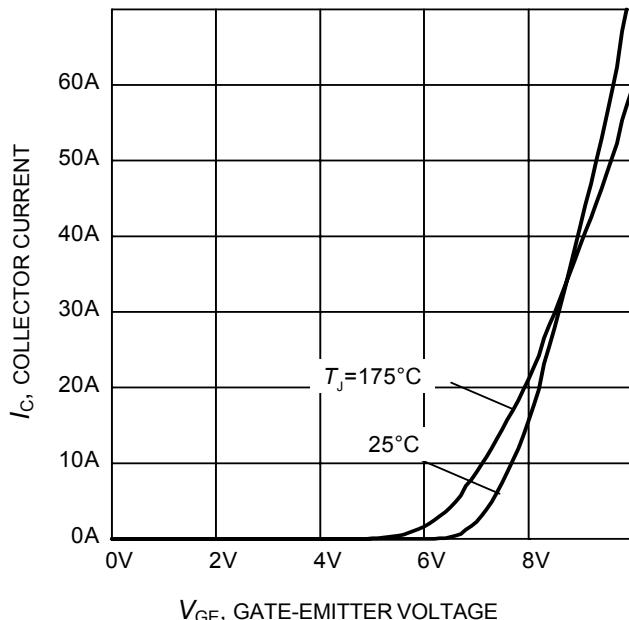
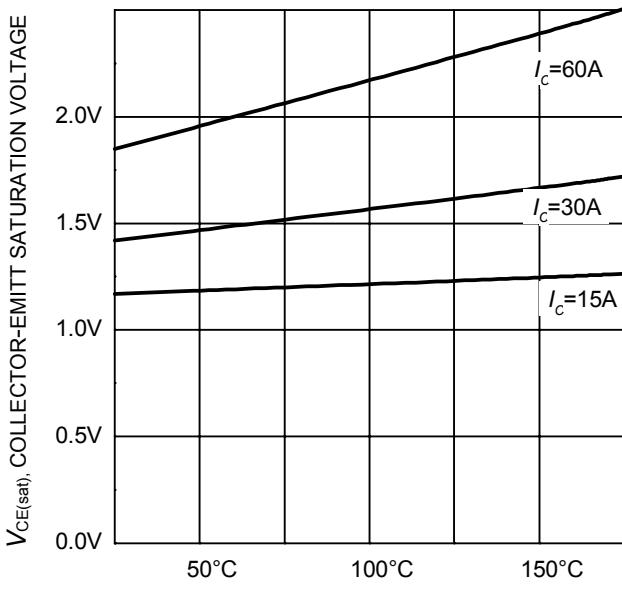
 T_C , CASE TEMPERATURE

Figure 4. Collector current as a function of case temperature
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$

 V_{GE} , COLLECTOR-EMITTER VOLTAGE**Figure 5. Typical output characteristic**
($T_j = 25^\circ\text{C}$) V_{GE} , COLLECTOR-EMITTER VOLTAGE**Figure 6. Typical output characteristic**
($T_j = 175^\circ\text{C}$) V_{GE} , GATE-EMITTER VOLTAGE**Figure 7. Typical transfer characteristic**
($V_{CE}=20\text{V}$) T_j , JUNCTION TEMPERATURE**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**
($V_{GE} = 15\text{V}$)



Soft Switching Series

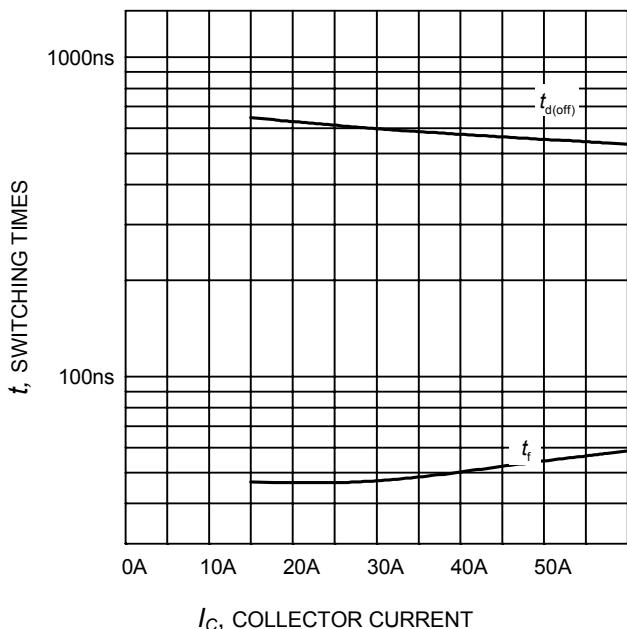


Figure 9. Typical switching times as a function of collector current
(inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $R_G=15\Omega$,
Dynamic test circuit in Figure E)

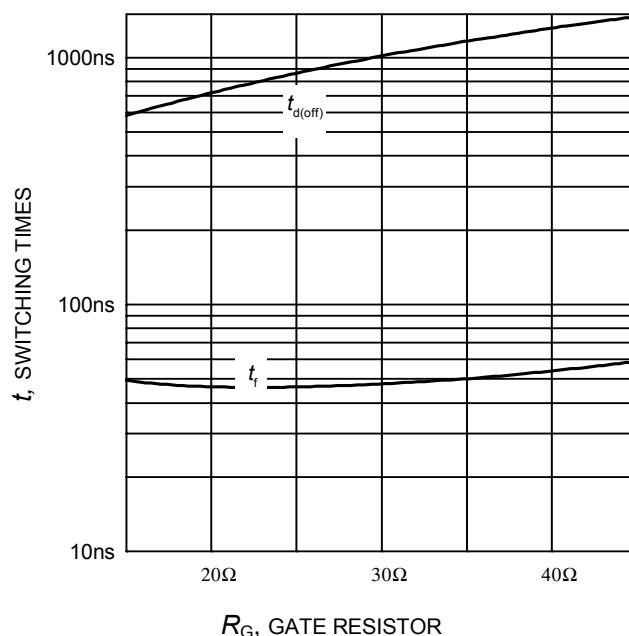


Figure 10. Typical switching times as a function of gate resistor
(inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$,
Dynamic test circuit in Figure E)

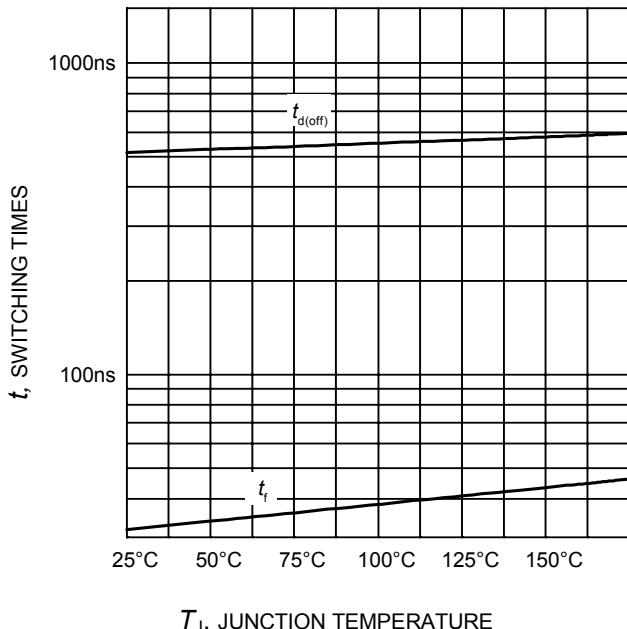


Figure 11. Typical switching times as a function of junction temperature
(inductive load, $V_{CE}=600\text{V}$,
 $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$, $R_G=15\Omega$,
Dynamic test circuit in Figure E)

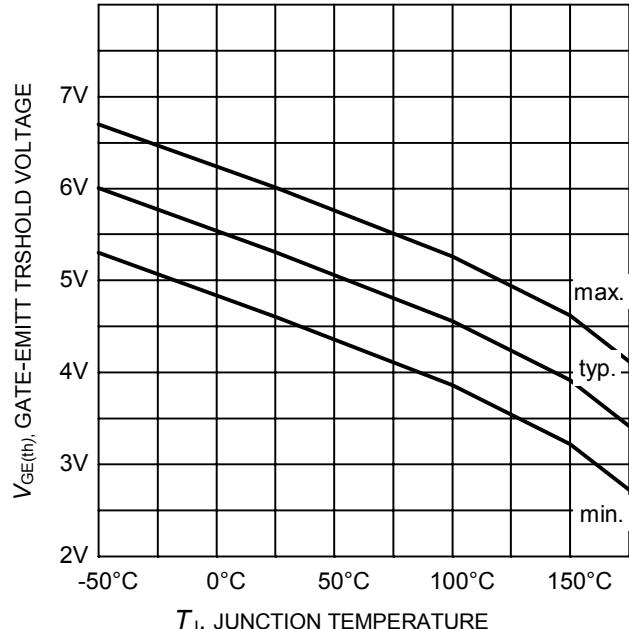


Figure 12. Gate-emitter threshold voltage as a function of junction temperature
($I_C = 0.7\text{mA}$)

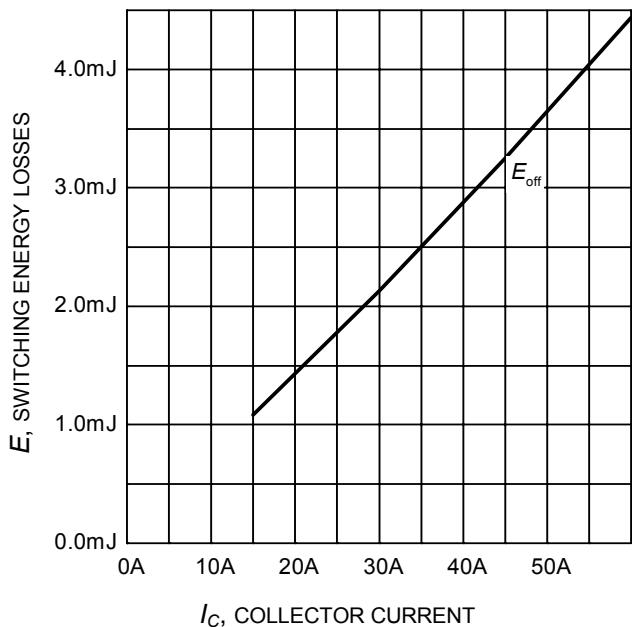


Figure 13. Typical switching energy losses as a function of collector current
 (inductive load, $T_J=175^\circ\text{C}$,
 $V_{\text{CE}}=600\text{V}$, $V_{\text{GE}}=0/15\text{V}$, $R_G=15\Omega$,
 Dynamic test circuit in Figure E)

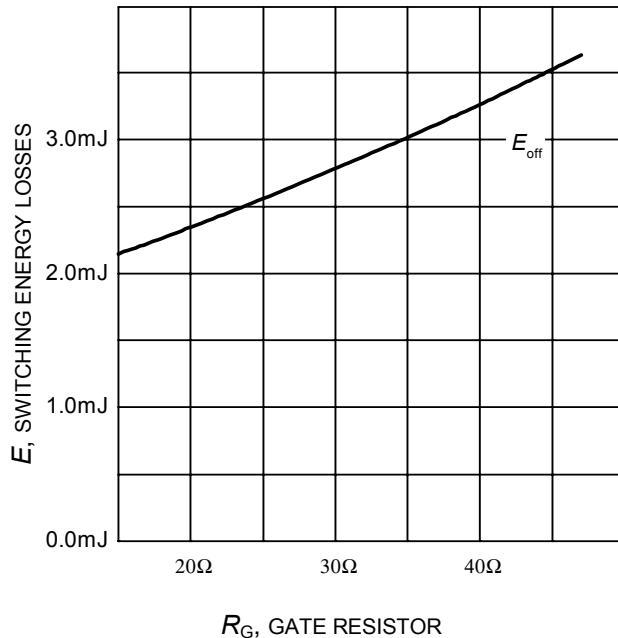


Figure 14. Typical switching energy losses as a function of gate resistor
 (inductive load, $T_J=175^\circ\text{C}$,
 $V_{\text{CE}}=600\text{V}$, $V_{\text{GE}}=0/15\text{V}$, $I_C=30\text{A}$,
 Dynamic test circuit in Figure E)

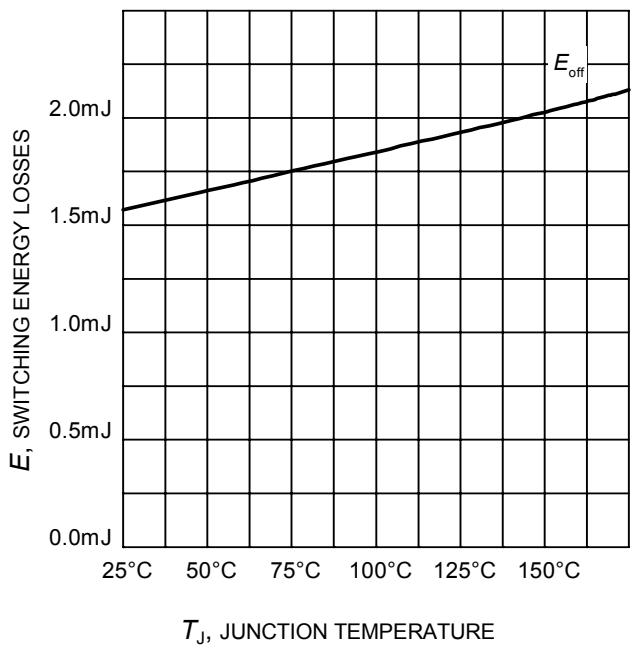
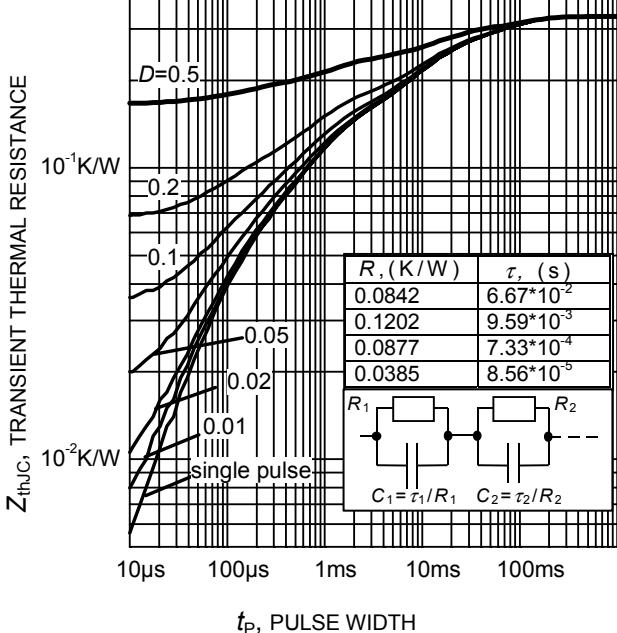
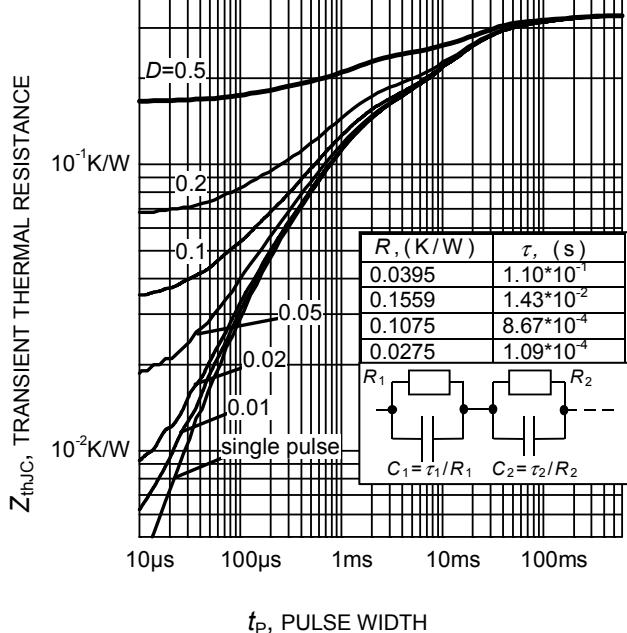
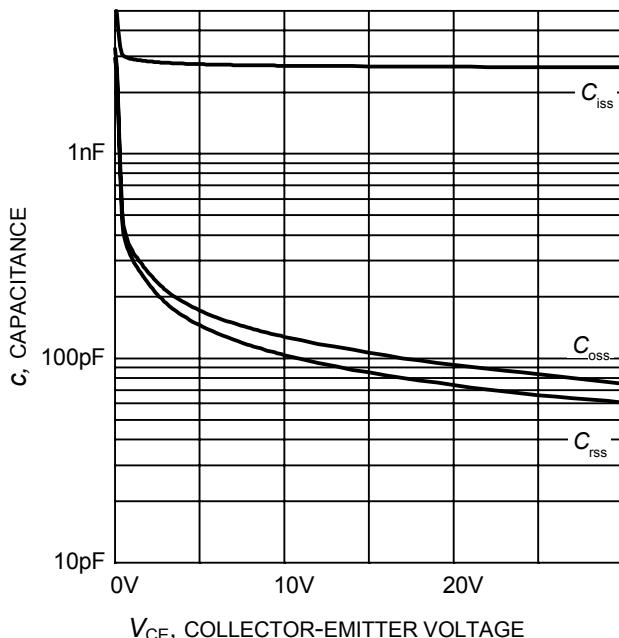
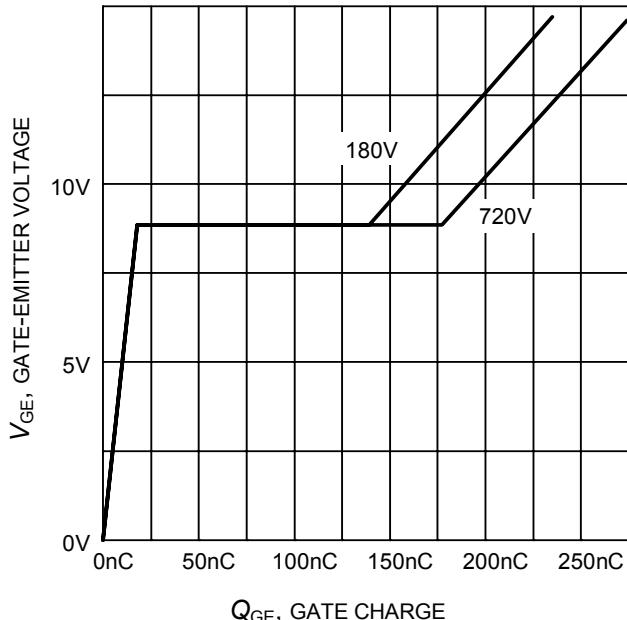


Figure 15. Typical switching energy losses as a function of junction temperature
 (inductive load, $V_{\text{CE}}=600\text{V}$,
 $V_{\text{GE}}=0/15\text{V}$, $I_C=30\text{A}$, $R_G=15\Omega$,
 Dynamic test circuit in Figure E)



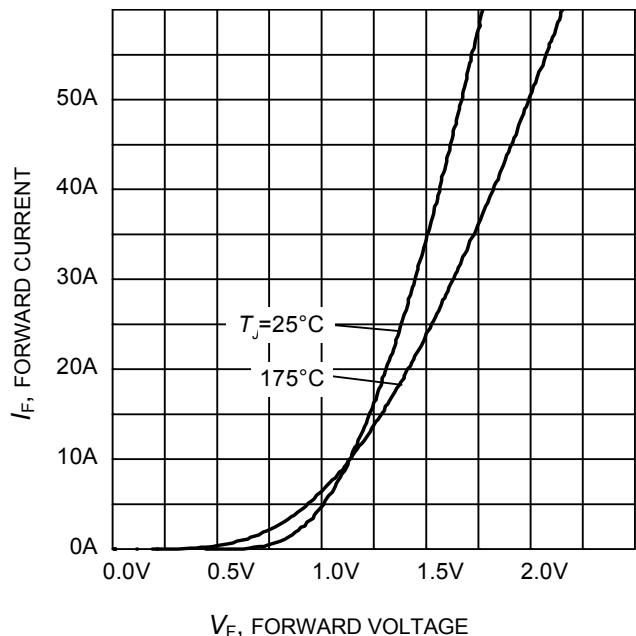


Figure 20. Typical diode forward current as a function of forward voltage

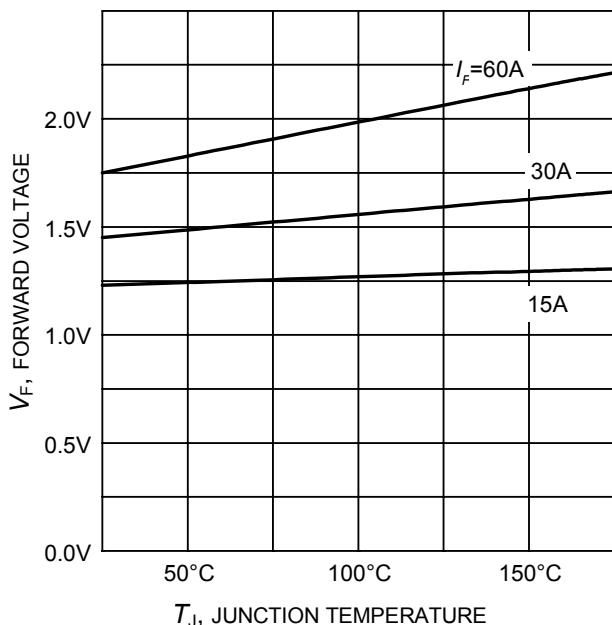
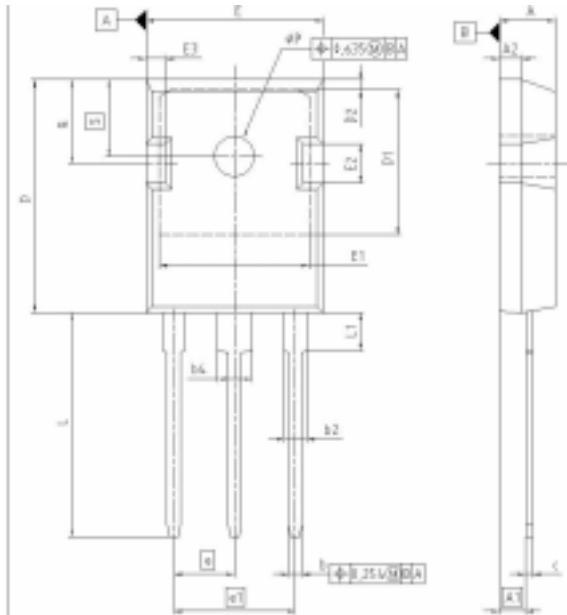


Figure 21. Typical diode forward voltage as a function of junction temperature

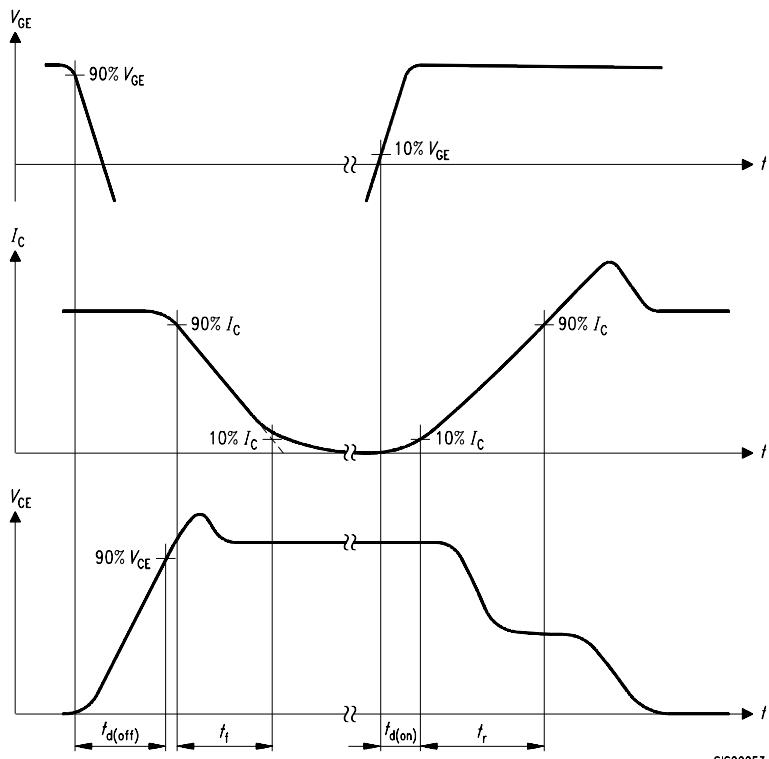
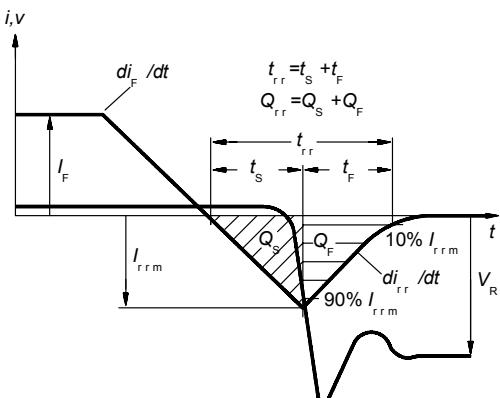
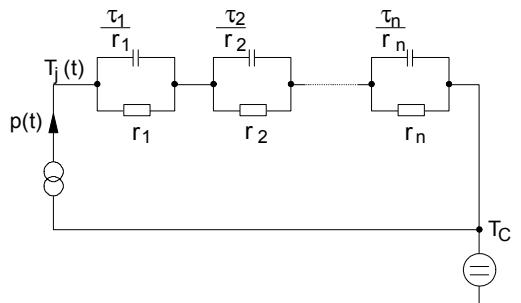
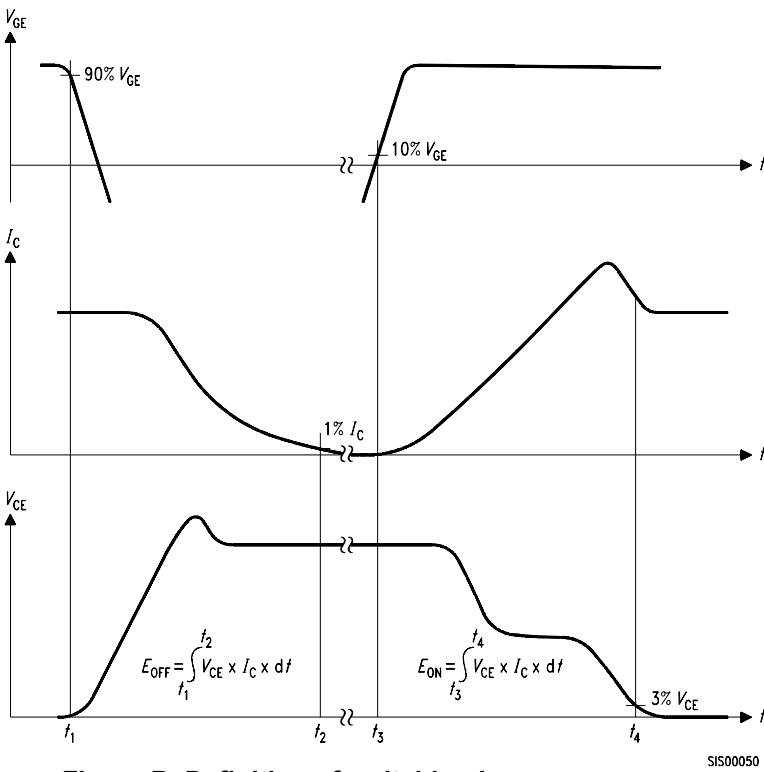
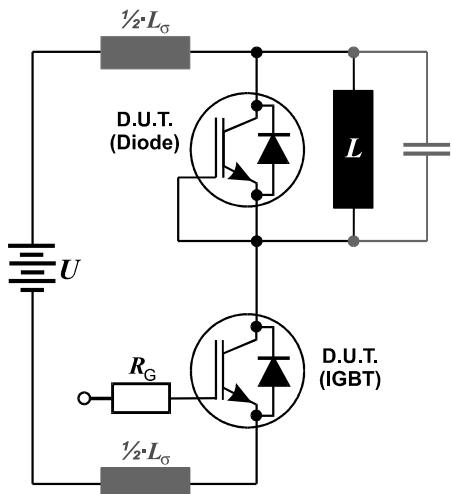


PG-T0247-3-21



| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|--------|--------|-------|
| | MIN | MAX | MIN | MAX |
| A | 4.905 | 5.157 | 0.193 | 0.203 |
| A1 | 2.273 | 2.527 | 0.092 | 0.098 |
| A2 | 1.853 | 2.107 | 0.073 | 0.081 |
| b | 1.073 | 1.327 | 0.042 | 0.052 |
| b2 | 1.903 | 2.306 | 0.075 | 0.094 |
| b4 | 2.970 | 3.454 | 0.113 | 0.138 |
| c | 0.549 | 0.752 | 0.021 | 0.030 |
| D | 29.823 | 21.077 | 0.820 | 0.830 |
| D1 | 17.323 | 17.631 | 0.682 | 0.702 |
| D2 | 1.083 | 1.317 | 0.042 | 0.052 |
| E | 15.773 | 16.027 | 0.614 | 0.634 |
| E1 | 13.893 | 14.547 | 0.547 | 0.567 |
| E2 | 3.883 | 3.907 | 0.149 | 0.155 |
| E3 | 1.663 | 1.937 | 0.065 | 0.075 |
| E4 | | 5.450 | | 0.215 |
| e1 | | 10.900 | | 0.430 |
| N | | 3 | | 3 |
| L | 20.053 | 20.307 | 0.790 | 0.799 |
| L1 | 4.166 | 4.472 | 0.164 | 0.178 |
| eP | 3.558 | 3.661 | 0.140 | 0.144 |
| Q | 5.493 | 5.747 | 0.219 | 0.228 |
| S | 6.913 | 6.297 | 0.238 | 0.248 |

Soft Switching Series

**Figure A. Definition of switching times****Figure C. Definition of diodes switching characteristics****Figure D. Thermal equivalent circuit****Figure B. Definition of switching losses****Figure E. Dynamic test circuit**



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